## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:			)	)	
Youzhi E. Xu		)	Examiner: Fischer, Justin R.		
U.S. Serial No:		10/781,314	)	Art Unit: 1791	
Filed:		02/17/2004	)	Confirmation: 4855	
For:	HEAT TRANSFER THROUGH COVALENT BONDING OF THERMAL INTERFACE MATERIAL		)		
	missioner for I Box 1450	Patents	/		
Alexa	ndria, VA 223	313-1450			

## AMENDMENT AND RESPONSE

Dear Sir:

This is in response to the Office Action mailed October 16, 2008. Applicant respectfully requests the Examiner to enter the following amendments and consider the following remarks.

## CERTIFICATE OF ELECTRONIC FILING

I hereby certify that this correspondence is being deposited with the United States Patent and Trademark Office via electronic filing through the United States Patent and Trademark Electronic Filing System on: January 9, 2009

Date of Pagesia.

Teresa Mattox				
Name of Person Filing Correspondence				
Tenso Naffay Signature	January 9, 2009 Date			